

FCU at a Glance.

Student-oriented. Education is our top priority.

Office of Student Recruitment and Admission

2026/3

www.fcu.edu.tw

FCU in Numbers



Founded in

1961

International
Sister Universities

260+

Industry–Academia Collaboration
and Project funding

NT\$1 billion

Students

20000+

Tuition-Waived
Exchange Opportunities

1000+

Total Scholarship Funding

NT\$290 million

Feng Chia University

3 Campuses

Fuxing Campus

Dormitory life offers a high-quality environment, diverse room types, and comprehensive facilities, with more than 3,300 beds to meet various housing needs.

Main Campus

Primarily focused on teaching and administrative functions. In 2019, an additional 2.7 hectares of land in Shuinan was acquired, and the Virtuosi Hall, officially inaugurated in February 2025, is also located here.

Central Taiwan Science Park Campus

Located within the Central Taiwan Science Park, it serves as an important base and platform for industry-academia collaboration between Feng Chia University and the Central Taiwan Science Park.



Main Campus





Virtuosi Hall



逢甲大學

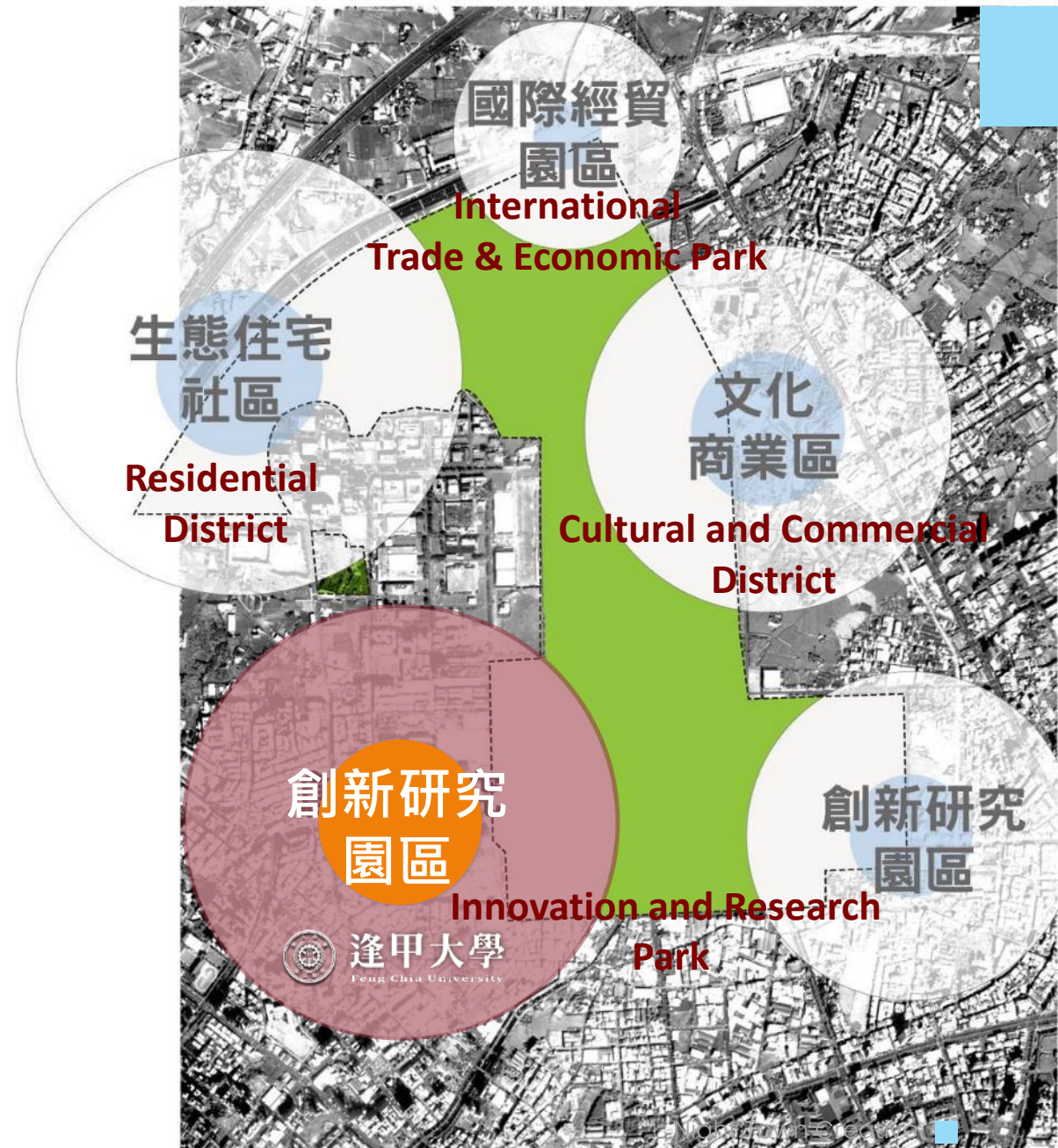
Central Taiwan Science Park Campus



Key Development Area of Taichung

Shuinan Economic and Trade Park

Feng Chia University — Living within it,
growing and thriving together.



Programs Information



College of Engineering and Science

Mechanical and Computer-Aided Engineering, Fiber and Composite Materials, Industrial Engineering and Systems Management, Chemical Engineering, Aerospace and Systems Engineering, Precision Systems Design, Electro-acoustics, Green Energy Science and Technology, Applied Mathematics, Materials Science and Engineering, Environmental Engineering and Science, Photonics, Data Science

College of Information and Electrical Engineering

Information Engineering and Computer Science, Electronic Engineering, Electrical Engineering, Automatic Control Engineering, Communications Engineering

i School

Artificial Intelligence Technology and Application

School of Architecture

Architecture, Interior Design

College of Engineering and Science

Civil Engineering, Water Resources Engineering and Conservation, Urban Planning and Spatial Information, Transportation and Logistic, Land Management, Infrastructure Planning and Engineering

International School of Technology and Management

RMIT-FCU 2+2 Bachelor's Program in Business and Innovation, SJSU-FCU 2+2 Bachelor's Program in Business Analytics, SJSU-FCU 2+2 Bachelor's Program in Electrical Engineering, SFSU-FCU 2+2 Bachelor's Program in Computer Science, UQ-FCU 2+2 Bachelor's Program in Business, Monash-FCU 2+2 Bachelor's Program in Information Technology, UQ-FCU 2+2 Bachelor's Program in Electrical Engineering, UNSW-FCU 2+2 Bachelor's Program in Design

College of Business

Accounting, International Business, Public Finance, Cooperative Economics and Social Entrepreneurship, Statistics, Economics, Business Administration, Marketing, , International Business Administration in English (BIBA), Financial and Economic Law

College of Finance

Finance, Risk Management and Insurance, Financial Engineering and Actuarial Science

College of Humanities and Social Sciences

Chinese Literature, Foreign Languages and Literature, Culture and Social Innovation

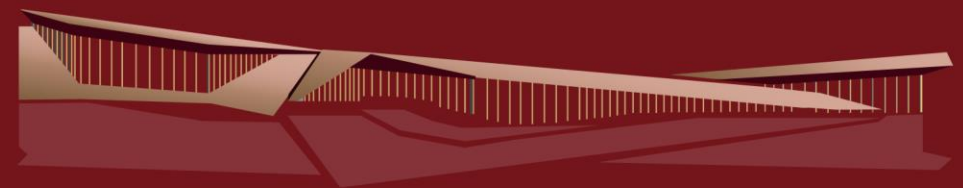
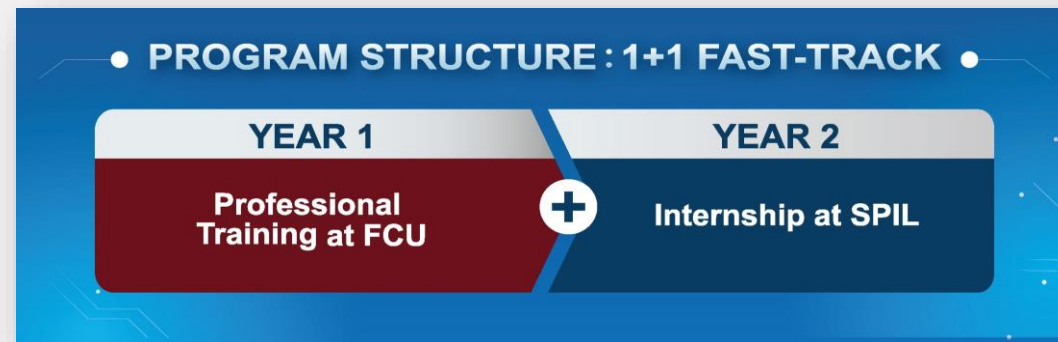
An architectural rendering of a modern building with a prominent wooden pergola structure on the left. The pergola has a series of horizontal slats and vertical posts, creating a shaded walkway. To the right of the walkway is a well-maintained green lawn with several young trees planted in a row. The building in the background has large glass windows and a clean, minimalist design. The overall scene is bright and sunny, with shadows cast across the lawn.

2026 INTENSE Program

**Department of Mechanical
and Computer-Aided
Engineering International
Master's Program in
Semiconductor
Engineering**

Program Features

- **Feng Chia University** has established an International Master's Program in Semiconductor Technology in collaboration with **Siliconware Precision Industries Co., Ltd. (SPIL)**. Through jointly designed and customized curricula, the program aims to foster high-level engineering talent for the semiconductor industry. Building upon the core strengths of the Department of Mechanical and Computer-Aided Engineering, the program integrates academic training with industrial practice.



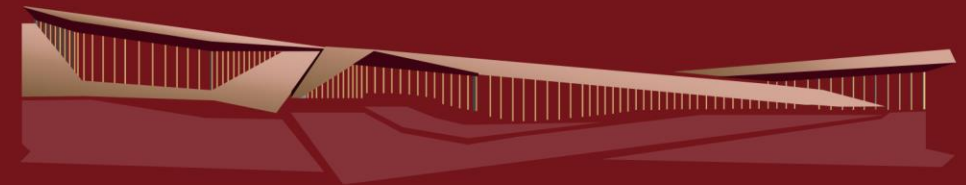
Program Features

The program is conducted entirely in English.

- **Graduation Credits: 32**

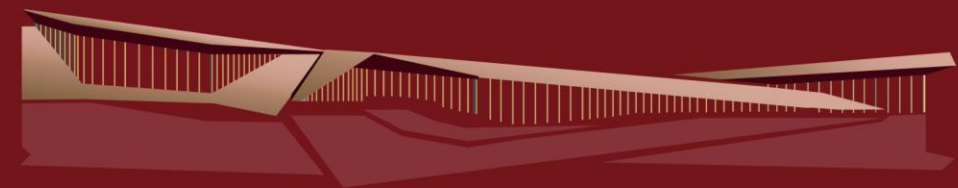
including 2 mandatory credits and 30 elective credits, of which 18 credits are earned through off-campus internship.

Industry Talent Needs and Job Descriptions	
Process Engineer	<ol style="list-style-type: none">1. New product implementation, execute equipment setup and pilot run.2. Engineering change management.3. Process capability improvement and investigation of process abnormalities



Introduction of Partner Company

- SPIL is a global leader in integrated circuit (IC) packaging and testing services. Its primary business focuses on the manufacturing, processing, sales, and testing of a wide range of IC packaging solutions.
- The company supplies packaging and testing solutions that are widely used in personal computers, communication devices, commercial and consumer electronics, and memory-related applications.



Application Period and Admission Quota

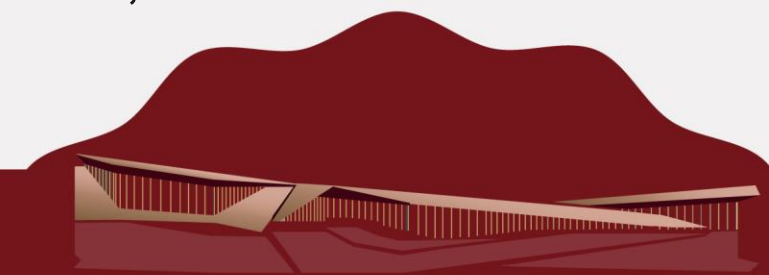
- Application period: March 5 — May 12, 2026
- Announcement of Admission Results: July 2, 2026
- Registration: September 8, 2026
- Admission Quota : 20



Application webpage

Applicant's Eligibility

- English proficiency certificate/proof required : CEFR B1 or above, such as TOEFL ITP 457, TOEFL CBT 137, TOEFL iBT 57, IELTS 4.0, or TOEIC 550.





Thank You ^o

Welcome to Feng Chia University.